

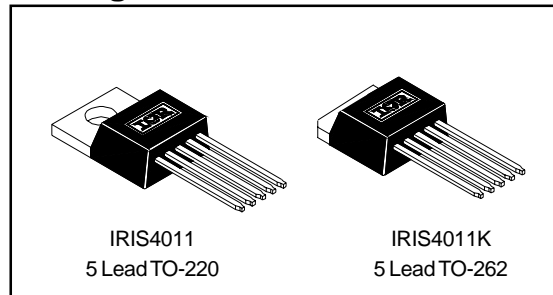
IRIS4011(K)

INTEGRATED SWITCHER

Features

- Primary current mode control, and secondary voltage mode control
- Vcc Over-voltage protection (latched)
- Over-current & over-temperature protection
- Quasi resonant, variable frequency operation
- 5 pin TO-220 and TO-262
- 3.9Ω Rds(on) max/ 650V MOSFET
- **Fully Characterized Avalanche Energy**

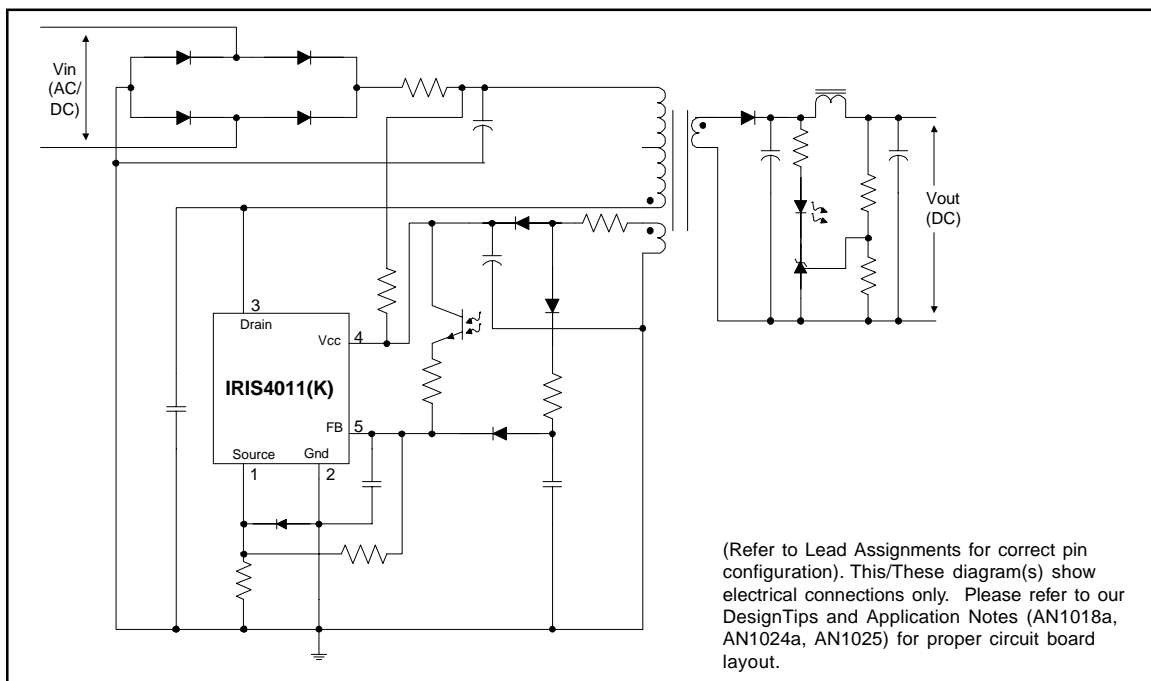
Packages



Description

The IRIS4011(K) is a dual mode voltage and current controller combined with a MOSFET in a single package. The IRIS4011(K) is designed for use in universal and single input AC/DC and DC/DC switching power supplies and is capable of powers up to 60W for a universal line input. The device can operate in either a quasi-resonant or Pulse Ratio Control (PRC) mode, and thereby variable frequency operation.

Typical Connection Diagram



Absolute Maximum Ratings

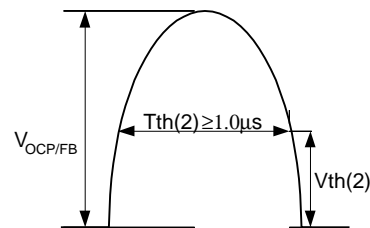
Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to terminals stated, all currents are defined positive into any lead. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

| Symbol | Definition | Terminals | Max. Ratings | Units | Note |
|-------------|------------------------------------------|-----------|--------------|--------------|-------------------------------------------------------|
| I_{Dpeak} | Peak drain current | 3-1 | 6.8 | A | Single pulse |
| I_{Dmax} | Maximum switching current | 3-1 | 2.7 | | $V_{2-3} = 0.78V$ $T_c = 25^\circ C$ |
| E_{AS} | Single pulse avalanche energy | 3-1 | 92 | mJ | $V_{dd} = 99V, L = 20mH,$ $G = 12V, I_{pk} = 2.8A$ |
| V_{CC} | Power supply voltage | 4-3 | 35 | V | |
| V_{TH} | OCP/FB terminal voltage | 5-2 | 6 | | |
| P_{D1} | Power dissipation for MOSFET | 3-1 | 89 | W | With infinite heatsink |
| | | | 1.4 | | Without heatsink |
| P_{D2} | Power dissipation for control part (MIC) | 4-2 | 0.8 | | Specified by $V_{IN} \times I_{IN}$ |
| R_{thJC} | Thermal resistance, junction to case | — | 1.4 | $^\circ C/W$ | |
| T_J | Junction temperature | — | -40-125 | $^\circ C$ | |
| T_S | Storage temperature | — | -40-125 | | |
| T_f | Internal frame temperature in operation | — | -20-125 | | Refer to recommended operating temperature |
| T_{OP} | Ambient operating temperature | — | -20-125 | | |
| T_L | Lead temp. (soldering, 10 seconds) | — | 300 | | |
| | | | | | |

Recommended Operating Conditions

Time for input of quasi resonant signals.

For the Quasi resonant signal inputted to the $V_{DCP/FB}$ terminal at the time of quasi resonant operation, the signal should be wider than $T_{th}(2)$



Electrical Characteristics (for Control IC)

$V_{CC} = 18V$, ($T_A = 25^\circ C$) unless otherwise specified.

| Symbol | Definition | Min. | Typ. | Max. | Units | Test Conditions |
|-----------------|-------------------------------------------------------|------|------|------|------------|----------------------|
| V_{CCUV+} | V_{CC} supply undervoltage positive going threshold | 14.4 | 16 | 17.6 | V | |
| V_{CCUV-} | V_{CC} supply undervoltage negative going threshold | 9 | 10 | 11 | | |
| I_{QCCUV} | UVLO mode quiescent current | — | — | 100 | μA | $V_{CC} < V_{CCUV+}$ |
| I_{QCC} | Quiescent operating VCC supply current | — | — | 30 | mA | |
| $T_{OFF(MAX)}$ | Maximum OFF time | 40 | — | 60 | μsec | |
| $T_{TH(2)}$ | Minimum input pulse width for quasi resonant signals | — | — | 1.0 | | |
| $T_{OFF(MIN)}$ | Minimum OFF time | — | — | 1.5 | | |
| $V_{TH(1)}$ | OCP/FB terminal threshold voltage 1 | 0.68 | 0.73 | 0.78 | V | |
| $V_{TH(2)}$ | OCP/FB terminal threshold voltage 2 | 1.3 | 1.45 | 1.6 | | |
| $I_{OCP/FB}$ | OCP/FB terminal sink current | 1.1 | 1.35 | 1.7 | mA | |
| $V_{CC(OVP)}$ | V_{CC} overvoltage protection limit | 20.5 | 22.5 | 24.5 | V | |
| $I_{CC(LA)}$ | Latch circuit holding current | — | — | 400 | μA | |
| $V_{CC(LaOFF)}$ | Latch circuit reset voltage | 6.6 | — | 8.4 | V | |
| $T_{J(TSD)}$ | Thermal shutdown activation temperature | 140 | — | — | $^\circ C$ | |

Electrical Characteristics (for MOSFET)

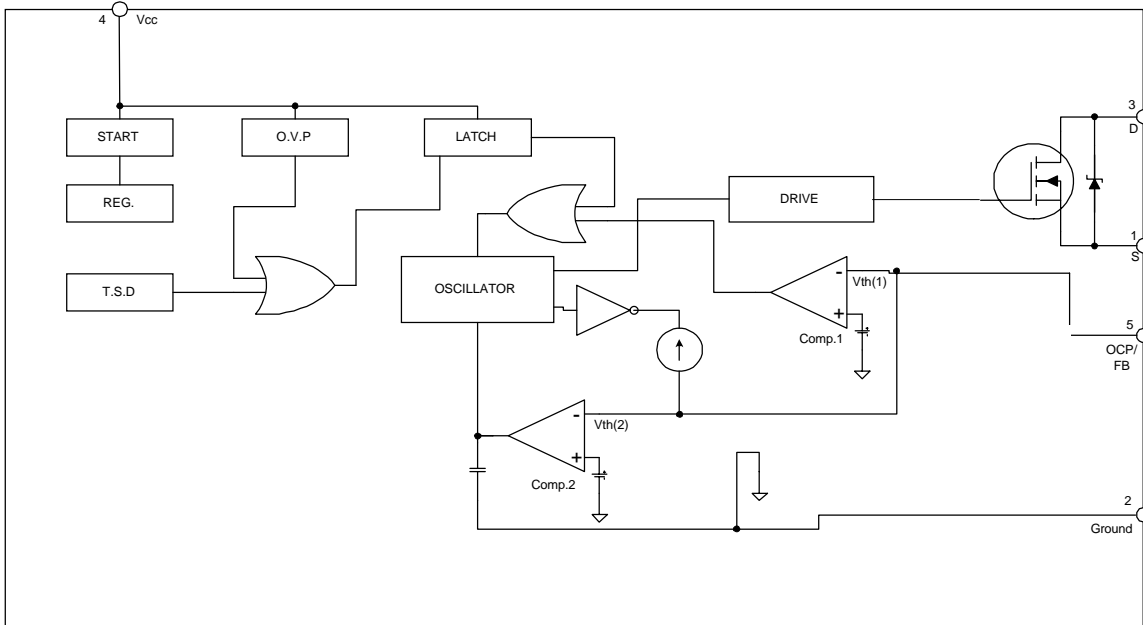
($T_A = 25^\circ C$) unless otherwise specified.

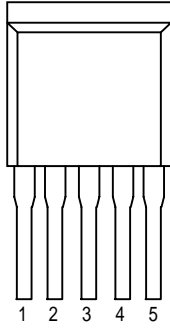
| Symbol | Definition | Min. | Typ. | Max. | Units | Test Conditions |
|----------------|-----------------------------------|------|------|------|--------------|-----------------------------------------------|
| V_{DSS} | Drain-to-source breakdown voltage | 650 | — | — | V | |
| I_{DSS} | Drain leakage current | — | — | 300 | μA | $V_{ds}=520V, V_{CC}=0V$ $T_j=125^\circ C$ |
| $R_{DS(ON)}$ | On-resistance | — | — | 3.9 | Ω | $V_{3-1}=10V, I_D=0.9A$ |
| t_r | Rise time (10% to 90%) | — | — | 250 | ns | |
| θ_{J-C} | Thermal resistance | — | — | 1.4 | $^\circ C/W$ | Between junction and case |

IRIS4011(K)

International
IR Rectifier

Block Diagram



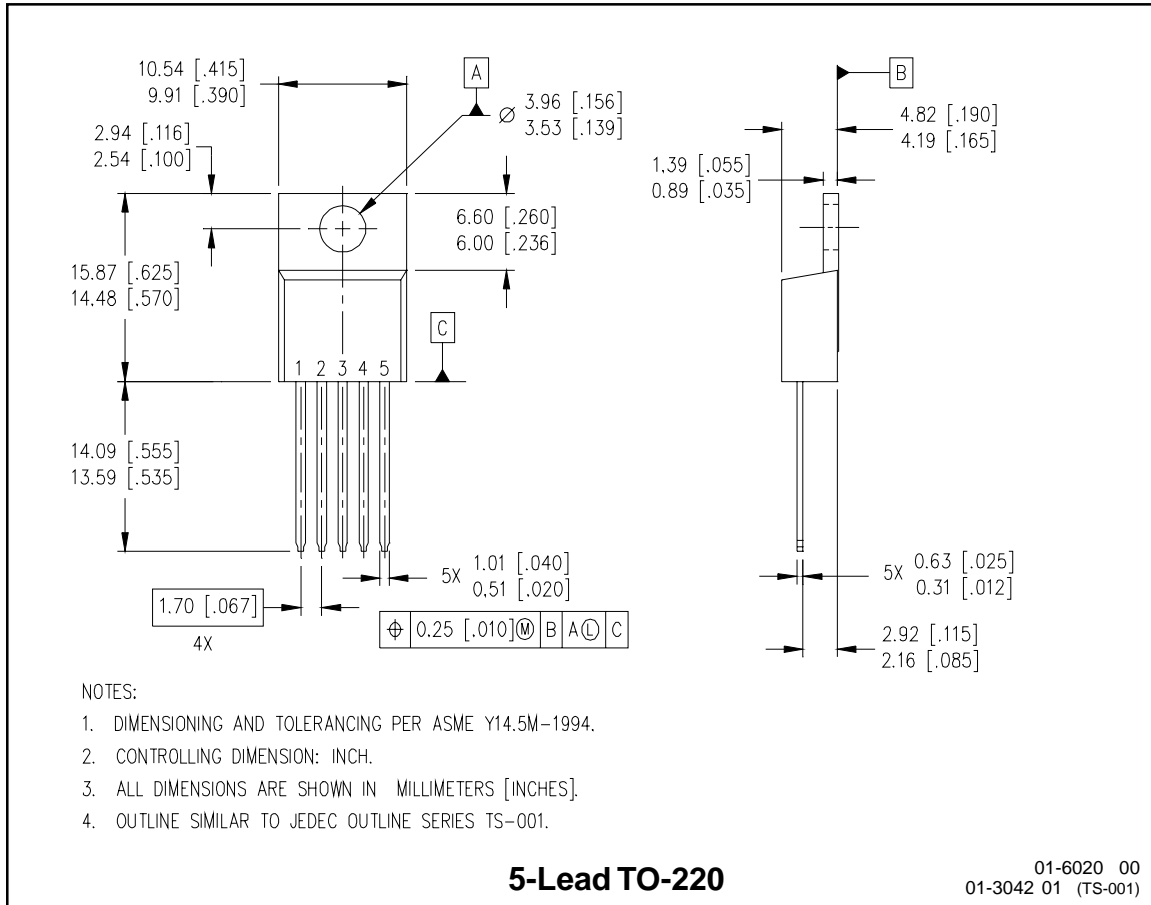
| Lead Assignments | Pin # | Symbol | Description |
|-------------------------------------------------------------------------------------|-------|--------|-----------------------------------------------------------------|
|  | 1 | S | MOSFET Source terminal |
| | 2 | Ground | Ground terminal |
| | 3 | D | MOSFET Drain terminal |
| | 4 | Vcc | Control circuit supply voltage |
| | 5 | OCP/FB | Overcurrent detection, and Voltage mode control feedback signal |

Other Functions

O.V.P. – Overvoltage Protection Circuit

T.S.D. – Thermal Shutdown Circuit

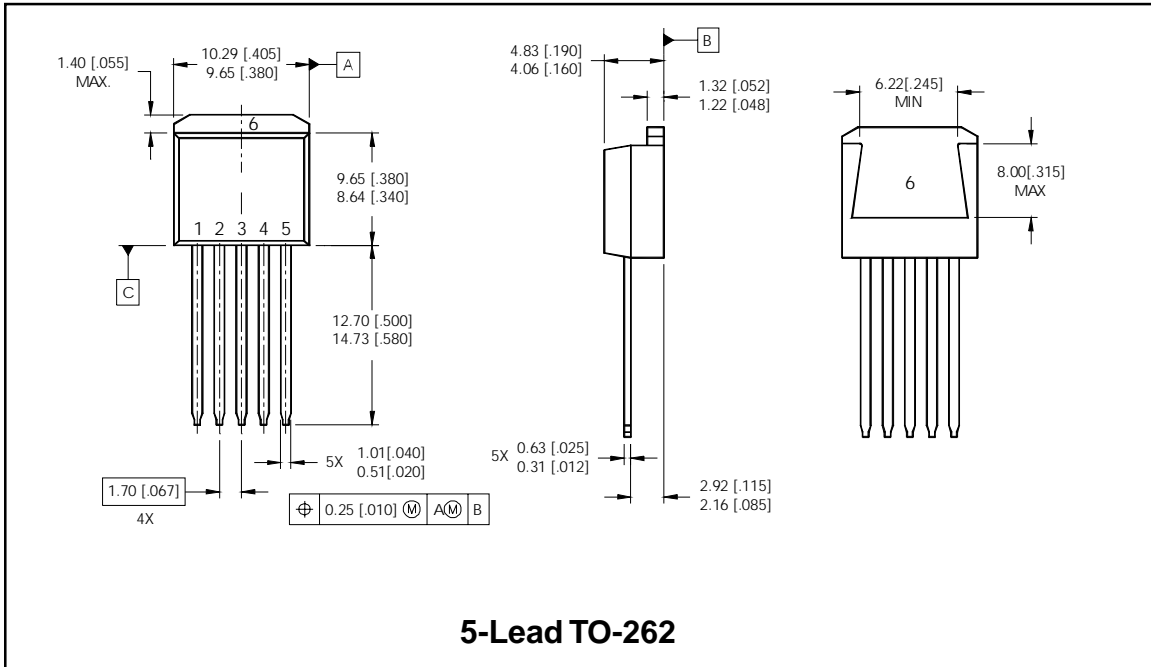
Case outline



IRIS4011(K)

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Case outline



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Data and specifications subject to change without notice. 10/162001